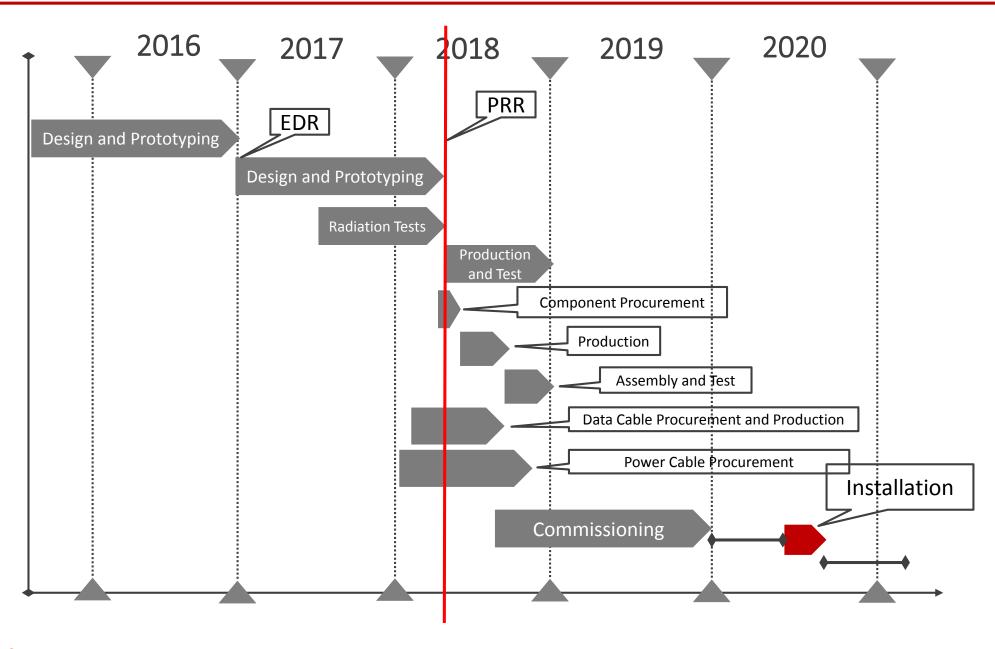


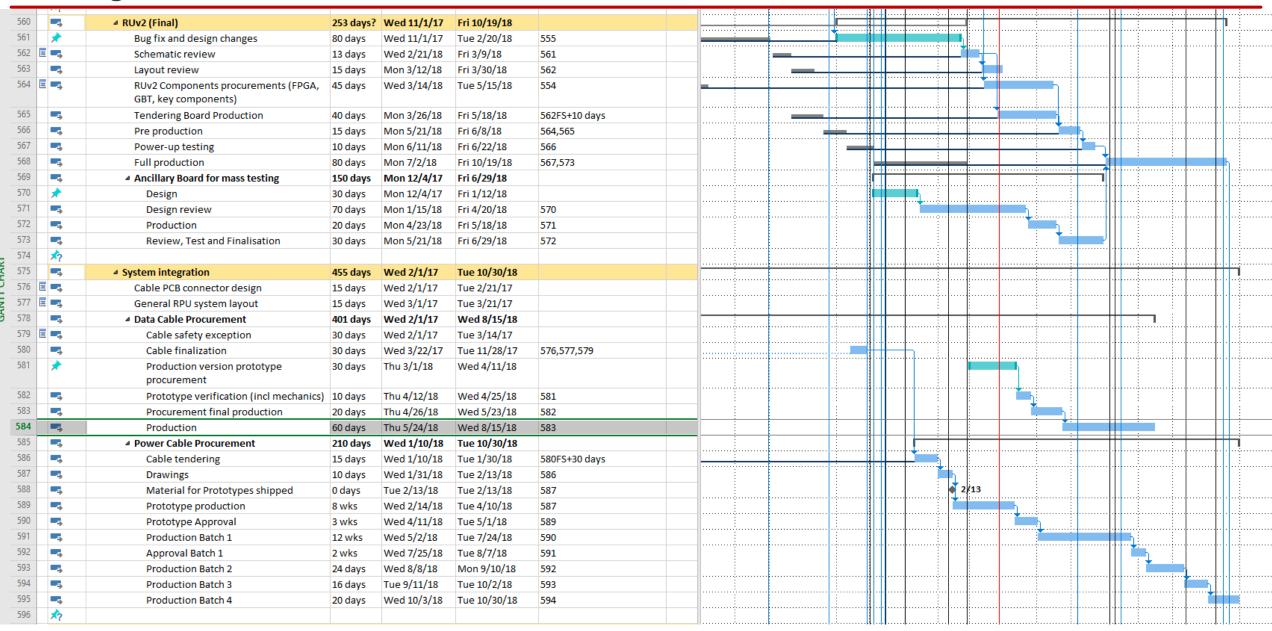
# **Planning** – overview on Radiation Facilities Tests and Conditions

Facility	Type of Radiation	Energy	Flux [cm <sup>-2</sup> s <sup>-1</sup> ]	Fluency / Max. Radiation Load	Device Tested	Test Objective
CHARM (CERN)	n, p, K, $\pi$ (mixed field)	24 GeV/c on Cu target	1.4e11 per day (spill pulse length 300ms, 3 spill per min)	About 2×10 <sup>11</sup> (tbc) HEH/cms <sup>2</sup> , 30 krad	Full System	Functional stability scrubbing
NPI Rez (Prague, CZ)(2 radiation campaigns)	р	30 MeV	O(1e7)	O(1×10 <sup>12</sup> ) p/cm <sup>2</sup> (tbc)	RU	Scrubbing
ChipIr (RAL, UK)	n	0 – 800 MeV	3.5e6	5×10 <sup>11</sup> n/cm <sup>2</sup>	RU+ IB Stave (not exposed to primary beam)	Functional stability scrubbing
NIF (UCL, Louvain- la-Neuve, BE)	n	0 – 50 MeV (20 MeV mean)	O(1e8)	1×10 <sup>14</sup> HEH/cm <sup>2</sup>	DC-DC	SEE
GIF++ (CERN)	γ	<sup>137</sup> Cs (662keV)	N/A	14.8 krad	Power board	TID Hardness

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### Planning – Detailed Gantt chart



## Planning – material/board procurement/production

#### Critical components procurement

Component	Due to	Status
ICs (FPGAs, memories)	Jun 2018	Ongoing
Fiberoptics	Sept 2018	Investigating
Crates	Sept 2019	Prototype ready

#### Boards production (and testing)

Commissioning	Due to	Readout Unit [cumulative]	Power Board [cumulative]	CRUs / FLP [cumulative]	Data cables [cumulative]
Layer 0	Sept 2018	12 [12]	6 [6]	2/1 [2/1]	12 [12]
Layer 1, 2	Feb 2018	16, 20 [48]	8, 10 [24]	4/2 [6/3]	16, 20 [48]
Layers 3, 4	Jun 2019	24, 30 [102]	12, 15 [51]	6/3 [12/6]	96, 120 [264]
Layers 5, 6	Sept 2019	42, 48 [192]	42, 48 [141]	12/6 [24/12]	168, 192 [624]
Total		192	141	24/12	624
Spares + R&D		28	16	<u> </u>	26

Actual CRU number can be reduced by a factor 3 for commissioning